

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Richard W. Wensel

Serial No.: 10/600,149

Filed: June 19, 2003

For: SEMICONDUCTOR DIE WITH
ATTACHED HEAT SINK AND
TRANSFER MOLD

Confirmation No.: 6258

Examiner: N. Ha

Group Art Unit: 2814

Attorney Docket No.: 2269-3061.8US
(96-0893.07/US)

RECEIVED

APR 14 2005

OFFICE OF PETITIONS

VIA HAND DELIVERY

**PETITION FOR WITHDRAWAL FROM ISSUE TO PERMIT CONSIDERATION OF
AN INFORMATION DISCLOSURE STATEMENT UNDER § 1.97 (37 C.F.R.
§ 1.313(c)(2))**

Mail Stop 313(c)
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Applicants hereby petition for the withdrawal of this application from issue. The issue fee for this case was paid on February 3, 2005. A copy of the issue fee transmittal is enclosed.

The reason for withdrawal of this application from issue is for consideration of an information disclosure statement under 37 C.F.R. § 1.97, which is filed herewith. Also, a Request for Continued Examination (RCE) from this application is filed on even date herewith.

Enclosed is a check in the sum of \$130.00 for the fee associated with this petition.

Serial No. 10/600,149

Should this amount be insufficient, any deficiency may be charged to Deposit Account 20-1469.

A duplicate of this petition is attached.

Respectfully submitted,



James R. Duzan
Registration No. 28,393
Attorney for Applicant
TRASKBRITT
P.O. Box 2550
Salt Lake City, Utah 84110-2550
Telephone: 801-532-1922

Date: April 13, 2005

JRD/dlm:lmh

Enclosures: Copy of this Petition
Copy of Part B – Issue Fee Transmittal
Check No. 7672 in the amount of \$130.00
Request of Continued Examination (RCE) Transmittal (1 page w/ duplicate copy)
Supplemental Information Disclosure Statement (4 pages)
Form PTO/SB/08A (2 pages), with cited references
Check No. 7671 in the amount of \$790.00

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